

adhering a third substrate to the layer to be peeled with a second adhesive, and sandwiching the layer to be peeled between the second substrate and the third substrate;

separating the film and the second substrate, and forming the layer to be peeled, for which the film, the second adhesive and the third substrate serve as a support; and

curving the third substrate.

10. A method according to claim 9, wherein the film is a tape with photosensitive adhesive on both sides or on one

side thereof, and in the separating the film and the second substrate, light is irradiated to separate the film and the second substrate.

11. A method according to claim 9, wherein the first substrate and the second substrate are materials which are more rigid than the third substrate.

12. A method according to claim 9, wherein the third substrate is a substrate which is bendable.

* * * * *